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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

PIKE ET AL.

Serial No. **09/741,754**

Filing Date: **DECEMBER 19, 2000**

For: **METHOD FOR MAKING ELECTRONIC
DEVICES INCLUDING SILICON AND
LTCC AND DEVICES PRODUCED
THEREBY**

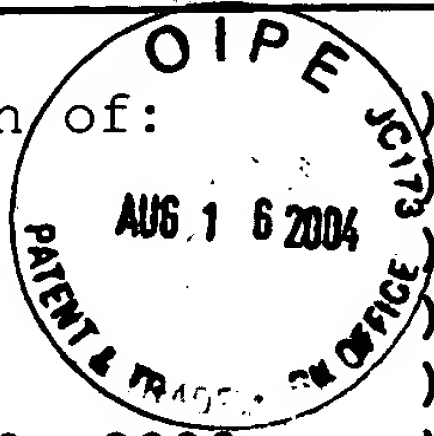
Examiner: **L. C. CRUZ**

Art Unit: **2827**

NOA Mailed: **7/28/04**

Attorney Docket:

GCSD-1096(51114)



COMMENTS ON STATEMENT OF REASONS FOR ALLOWANCE

Mail Stop ISSUE FEE

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

The Examiner is thanked for his careful examination and review of the present application and for allowing the present application in response to Applicants' Appeal Brief. The Examiner identifies published international application WO 01/29890 and states that it is not available as prior art. Applicants note that even if WO 01/29890 were available as a prior art reference, it discloses the need to use a sodium containing paste to form the anodic bond, and, moreover, it fails to teach or suggest any of the cooling features in many of the claims of the present application.

Respectfully submitted,

CHRISTOPHER F. REGAN

Reg. No. 34,906

Allen, Dyer, Doppelt, Milbrath
& Gilchrist, P.A.

255 S. Orange Avenue, Suite 1401

Orlando, Florida 32801

407-841-2330

In re Patent Application of:

PIKE ET AL.

Serial No. **09/741,754**

Confirmation No. **6488**

Filed: **12/19/00**

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 11th day of August, 2004.

